

3. (Amended) A magnetic [recording] head according to claim [2] 1, wherein said recording track layer comprises at least one of a read track and a write track.

4. (Amended) A magnetic [recording] head according to claim 3, wherein at least one of said gluing vias are trenched on said side surface of said substrate between said at least one of a read track and a write track.

5. (Amended) A magnetic [recording] head according to claim 1 wherein said gluing vias are photolithographically defined and subsequently trenched on said side surfaces.

6. (Amended) A magnetic tape head for reading from and writing to a magnetic tape moving across the head, comprising:

a substrate having a gap side surface;

a closure having a gap side surface that opposes and is separated from said gap side surface of said substrate by a gap;

a thin film layer deposited on said gap side surface of said substrate in said gap, wherein said thin film layer comprises a recording track layer and has a nonplanar topography along said gap;

[one or more] a plurality of gluing vias [on either or both of] formed between said substrate and said closure; and

adhesive in said gap and said gluing vias.

Cancel Claim 7 without prejudice or disclaimer.

8. (Amended) A magnetic tape head according to claim [7] 6, wherein said recording track layer comprises at least one of a read track and a write track.

9. (Amended) A magnetic tape head according to claim 8 wherein at least one of said gluing vias are trenched on said side surface of said substrate between said at least one of a read track and a write track.

10. (Amended) A magnetic [recording] tape head according to claim 6 wherein said gluing vias are photolithographically defined and subsequently trenched on [one or both] at least one of said gap side surfaces of said substrate and said closure.

11. (Amended) A method of manufacturing a multi-track tape head for at least one of reading from and writing to a medium, comprising the steps of:

depositing a recording track layer on a substrate;

forming a C-core in a closure;

trenching gluing vias on a gap side surface of [either or both] at least one of said substrate

and [a] said closure; and

bonding said substrate and said closure together by introducing adhesive into said C-core and said gluing vias.

12. A method according to claim 11, wherein said step of forming said recording track comprises forming at least one of a read track and a write track on said substrate.

13. A method according to claim 11, wherein said step of trenching includes the step of photolithographically defining said gluing vias.

14. (Amended) A method according to claim 11 [further including] wherein the step of forming a C-core includes the step of [machining a] forming said C-core on said gap side surface of said closure.

Cancel Claim 15 without prejudice or disclaimer.

16. (Amended) [A method according to claim 11] A method of manufacturing a multi-track tape head for at least one of reading from and writing to a medium, comprising the steps of:

depositing a recording track layer on a substrate;

forming gluing vias on a gap side surface of at least one of said substrate and a closure,

wherein at least one of said gluing vias are trenched on said side surface of said substrate between a read track and a write track on said recording track layer; and

bonding said substrate and said closure together by introducing adhesive into said gluing

vias.

Add Claim 17. The method of Claim 16 further comprising the step of forming a C-core on said gap side surface of said closure.

Sub E17
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Add Claim 18. The method of Claim 17 wherein said step of bonding includes the step of introducing said adhesive into said C-core.

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Sub E1
~~Add Claim 19. The magnetic head of Claim 1 formed in accordance with the method of Claim 11.~~

Add Claim 20. The magnetic head of Claim 1 wherein at least a portion of said plurality of gluing vias intersects said C-core.

Respectfully submitted,
YI-SHUNG CHAUG

By: 

Wayne P. Bailey

Registration No. 34,289

Attorney for Applicant

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STORAGE TECHNOLOGY CORPORATION

One StorageTek Drive, MS-4309

Louisville, Colorado 80028-4309

(303) 673-8223